TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC377AP, TC74HC377AF

Octal D-Type Flip-Flop

The TC74HC377A is a high speed CMOS OCTAL D-TYPE FLIP-FLOP fabricated with silicon gate $\rm C^2MOS$ technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

This 8-bit D-type flip-flop is controlled by a clock input (CK) and an output enable input (\overline{G}).

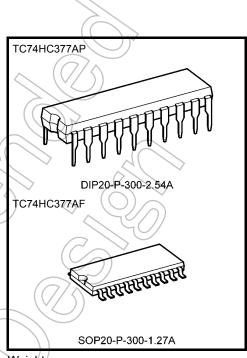
The signal level applied to the D inputs are transferred to Q outputs during the positive going transition of CK.

When the $\overline{\mathbf{G}}$ is high, the eight outputs are in a high impedance state.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

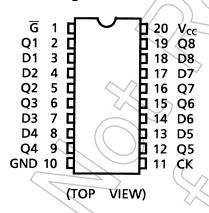
- High speed: $f_{max} = 73 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A$ (max) at $T_a = 25^{\circ}C$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 4 mA (min)
- Balanced propagation delays: t_{pLH} ≃ t_{pHL}
- Wide operating voltage range: V_{CC} (opr) = 2 to 6 V
- Pin and function compatible with 74LS377



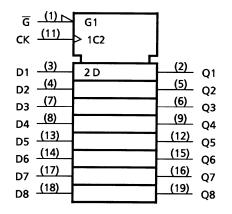
Weight

DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.)

Pin Assignment



IEC Logic Symbol

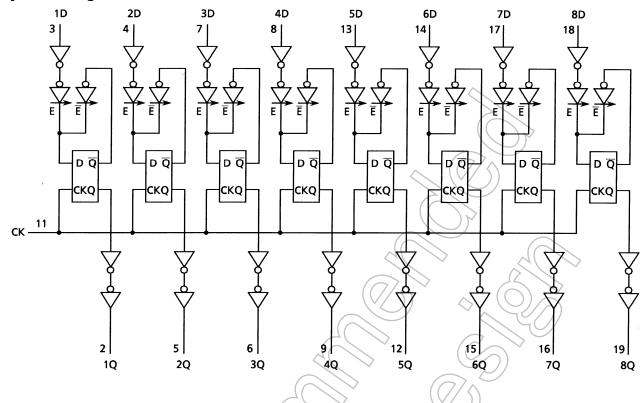


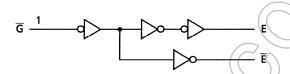
Truth Table

	Inputs	Outputs		
G	CK	D	Q	
Н	Х	Х	No Change	
L		L	L	
L		Н	Н	
Х	\neg	Х	No Change	

X: Don't care

System Diagram





Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	→ V _{CC} <	_0.5 to 7	V
DC input voltage	VIN	-0.5 to V _{CC} + 0.5	V
DC output voltage	Vout	-0.5 to V _{CC} + 0.5	V
Input diode current	lik	±20	mA
Output diode current	lok	±20	mA
DC output current	TOUT	±25	mA
DC V _{CC} /ground current	ICC	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to $65^{\circ}C$. From Ta = 65 to $85^{\circ}C$ a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	⟨v v
Operating temperature	T _{opr}	-40 to 85	°C
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	$\langle \rangle \rangle$

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

				<u> </u>))	\sim				
Characteristics	Symbol		Test Condition		Ta = 25°C			Ta 40 to	Unit	
	•			V _{CC} (V)	Min	Тур. (Max	Min	Max	
				2.0	1.50		(-1)	1.50	_	
High-level input voltage	V _{IH}		- (4.5	3.15	(7/<	\ _	3.15	_	V
Ů				6.0	4.20		/ _	4.20		
				2.0	_ \	//-	0.50	_	0.50	
Low-level input voltage	V_{IL}	((4.5	/_) <i>)</i> —	1.35	_	1.35	V
				6.0		/ _	1.80	_	1.80	
		(('<		2.0	1.9	2.0	_	1.9	_	
High lavel systems			I _{OH} = -20 μA	4.5	4.4	4.5	_	4.4	_	
High-level output voltage	V _{OH}	VIN = VIH		6.0	5.9	6.0	_	5.9	_	V
			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
	() !-	7	$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
		_		2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	> V _{OL}	$V_{IN} = V_{IL} \\$		6.0	_	0.0	0.1	_	0.1	V
\ \		\wedge	$I_{OL} = 4 \text{ mA}$	4.5	_	0.17	0.26	_	0.33	
		4	$I_{OL} = 5.2 \text{ mA}$	6.0	_	0.18	0.26	_	0.33	
Input leakage current) I _{IN}	V _{IN} = V _{CC} or	GND	6.0	_	—	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	$V_{IN} = V_{CC}$ or	GND	6.0	_	—	4.0		40.0	μΑ



Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	Test Condition		Ta = 25°C		Unit
			V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulgo width	t a.n		2.0	_	75	95	
Minimum pulse width	t _{W (H)}	_	4.5 <	_	15	19	ns
(CK)	t _{W (L)}		6.0		13	16	
Minimum and un time			2.0	(-	75	95	
Minimum set-up time	ts	_	4.5		15	19	ns
(D-CK)		4	6.0	<pre>/ ()</pre>	13	16	
Minimum act un tima			2.0		75	95	
Minimum set-up time (G-CK)	ts	_	4.5	> _	15	19	ns
(G-CK)			6.0	_	13_	16	
		4(2.0	_	46	9	
Minimum hold time	t _h	-	4.5	-/	0	0	ns
		$(\langle // $	6.0	-((0	0	
			2.0	4	4	6	
Clock frequency	f		4.5	>-/	36	29	MHz
		4()	6.0	$\langle \gamma \rangle$	42	34	

AC Characteristics (C_L = 15 pF, V_{CC} = 5 V_r Ta = 25°C, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t _{TLH}		_	4	8	ns
Propagation delay time	(tplH)		_	14	24	ns
(CK-Q)	tpHL					
Maximum clock frequency	fmax		38	73	_	MHz

AC Characteristics ($C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	-		V _{CC} (V)	Min	Тур.	Max	Min	Max	
	4 —		2.0	_	30	75	_	95	
Output transition time	t _{TLH}	_	4.5	_	8 <	15	_	19	ns
	t _{THL}		6.0	_	7	13	_	16	
Propagation delay	t _{pLH}		2.0	_	57	(140	4	175	
time		_	4.5	_	17	28	<i>7</i> _	35	ns
(CK-Q)			6.0	₹\	13(/	24	_	30	
	f _{max}		2.0	7	18		6	_	
Maximum clock frequency		_	4.5	36 (59	> —	29	_	MHz
noquonoy			6.0	42	77	_	34	_	
Input capacitance	C _{IN}		<	1(-/	5	10	4	10/	pF
Power dissipation capacitance	C _{PD} (Note)		(7)		32	-6		> -	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$ (per flip flop)

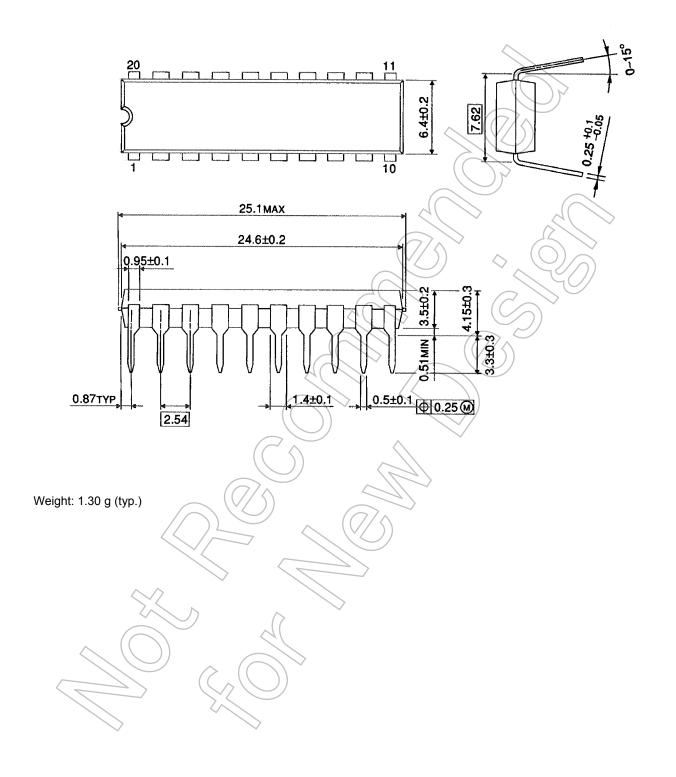
And the total C_{PD} when n pcs. of flip flop operate can be gained by the following equation:

$$C_{PD}$$
 (total) = 22 + 10 · n



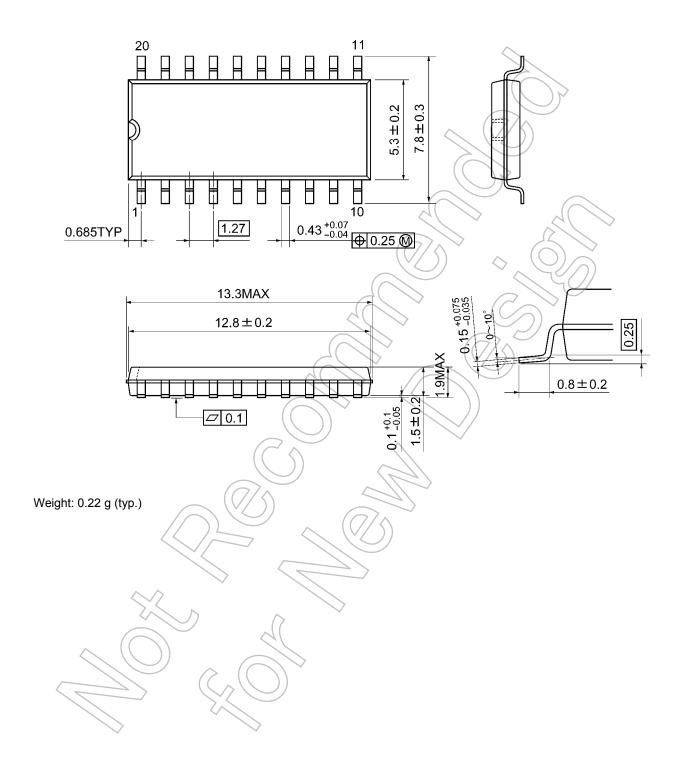
Package Dimensions

DIP20-P-300-2.54A Unit: mm



Package Dimensions

SOP20-P-300-1.27A Unit: mm



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